

Designer's™ Data Sheet

Insulated Gate Bipolar Transistor with Anti-Parallel Diode

N-Channel Enhancement-Mode Silicon Gate

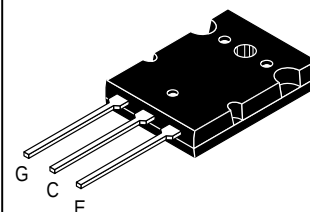
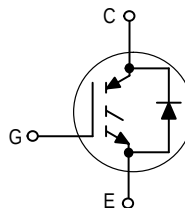
MGY25N120D

Motorola Preferred Device

IGBT & DIODE IN TO-264
25 A @ 90°C
38 A @ 25°C
1200 VOLTS
SHORT CIRCUIT RATED

This Insulated Gate Bipolar Transistor (IGBT) is co-packaged with a soft recovery ultra-fast rectifier and uses an advanced termination scheme to provide an enhanced and reliable high voltage-blocking capability. Short circuit rated IGBT's are specifically suited for applications requiring a guaranteed short circuit withstand time such as Motor Control Drives. Fast switching characteristics result in efficient operation at high frequencies. Co-packaged IGBT's save space, reduce assembly time and cost.

- Industry Standard High Power TO-264 Package (TO-3PBL)
- High Speed E_{off} : 226 μ s per Amp typical at 125°C
- High Short Circuit Capability – 10 μ s minimum
- Soft Recovery Free Wheeling Diode is included in the package
- Robust High Voltage Termination
- Robust RBSOA



CASE 340G-02, Style 5
TO-264

MAXIMUM RATINGS ($T_J = 25^\circ\text{C}$ unless otherwise noted)

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V_{CES}	1200	Vdc
Collector-Gate Voltage ($R_{GE} = 1.0 \text{ M}\Omega$)	V_{CGR}	1200	Vdc
Gate-Emitter Voltage — Continuous	V_{GE}	± 20	Vdc
Collector Current — Continuous @ $T_C = 25^\circ\text{C}$ — Continuous @ $T_C = 90^\circ\text{C}$ — Repetitive Pulsed Current (1)	I_{C25} I_{C90} I_{CM}	38 25 76	Adc Adc Apk
Total Power Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D	212 1.69	Watts W/ $^\circ\text{C}$
Operating and Storage Junction Temperature Range	T_J, T_{stg}	-55 to 150	$^\circ\text{C}$
Short Circuit Withstand Time ($V_{CC} = 720 \text{ Vdc}$, $V_{GE} = 15 \text{ Vdc}$, $T_J = 125^\circ\text{C}$, $R_G = 20 \Omega$)	t_{sc}	10	μs
Thermal Resistance — Junction to Case – IGBT — Junction to Case – Diode — Junction to Ambient	$R_{\theta JC}$ $R_{\theta JD}$ $R_{\theta JA}$	0.6 0.9 35	$^\circ\text{C/W}$
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 5 seconds	T_L	260	$^\circ\text{C}$
Mounting Torque, 6-32 or M3 screw	10 lbf•in (1.13 N•m)		

(1) Pulse width is limited by maximum junction temperature. Repetitive rating.

Designer's Data for "Worst Case" Conditions — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

Preferred devices are Motorola recommended choices for future use and best overall value.



MGY25N120D

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Collector-to-Emitter Breakdown Voltage (V _{GE} = 0 Vdc, I _C = 25 μAdc) Temperature Coefficient (Positive)	BV _{CES}	1200 —	— 960	— —	Vdc mV/°C
Zero Gate Voltage Collector Current (V _{CE} = 1200 Vdc, V _{GE} = 0 Vdc) (V _{CE} = 1200 Vdc, V _{GE} = 0 Vdc, T _J = 125°C)	I _{CES}	— —	— —	100 2500	μAdc
Gate-Body Leakage Current (V _{GE} = ± 20 Vdc, V _{CE} = 0 Vdc)	I _{GES}	—	—	250	nAdc
ON CHARACTERISTICS (1)					
Collector-to-Emitter On-State Voltage (V _{GE} = 15 Vdc, I _C = 12.5 Adc) (V _{GE} = 15 Vdc, I _C = 12.5 Adc, T _J = 125°C) (V _{GE} = 15 Vdc, I _C = 25 Adc)	V _{CE(on)}	— — —	2.37 2.15 2.98	3.24 — 4.19	Vdc
Gate Threshold Voltage (V _{CE} = V _{GE} , I _C = 1.0 mAdc) Threshold Temperature Coefficient (Negative)	V _{GE(th)}	4.0 —	6.0 10	8.0 —	Vdc mV/°C
Forward Transconductance (V _{CE} = 10 Vdc, I _C = 20 Adc)	g _{fe}	—	12	—	Mhos
DYNAMIC CHARACTERISTICS					
Input Capacitance	(V _{CE} = 25 Vdc, V _{GE} = 0 Vdc, f = 1.0 MHz)	C _{ies}	—	1859	pF
Output Capacitance		C _{oes}	—	198	
Transfer Capacitance		C _{res}	—	30	
SWITCHING CHARACTERISTICS (1)					
Turn-On Delay Time	(V _{CC} = 720 Vdc, I _C = 25 Adc, V _{GE} = 15 Vdc, L = 300 μH R _G = 20 Ω, T _J = 25°C) Energy losses include “tail”	t _{d(on)}	—	91	ns
Rise Time		t _r	—	124	
Turn-Off Delay Time		t _{d(off)}	—	196	
Fall Time		t _f	—	310	
Turn-Off Switching Loss		E _{off}	—	2.44	mJ
Turn-On Switching Loss		E _{on}	—	3.14	
Total Switching Loss		E _{ts}	—	5.58	
Turn-On Delay Time	(V _{CC} = 720 Vdc, I _C = 25 Adc, V _{GE} = 15 Vdc, L = 300 μH R _G = 20 Ω, T _J = 125°C) Energy losses include “tail”	t _{d(on)}	—	88	ns
Rise Time		t _r	—	126	
Turn-Off Delay Time		t _{d(off)}	—	236	
Fall Time		t _f	—	640	
Turn-Off Switching Loss		E _{off}	—	5.40	mJ
Turn-On Switching Loss		E _{on}	—	5.03	
Total Switching Loss		E _{ts}	—	10.43	
Gate Charge	(V _{CC} = 720 Vdc, I _C = 25 Adc, V _{GE} = 15 Vdc)	Q _T	—	62	nC
		Q ₁	—	22	
		Q ₂	—	25	
DIODE CHARACTERISTICS					
Diode Forward Voltage Drop (I _{EC} = 12.5 Adc) (I _{EC} = 12.5 Adc, T _J = 125°C) (I _{EC} = 25 Adc)	V _{FEC}	— — —	2.89 1.75 3.65	3.50 — 4.45	Vdc

(1) Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.

(continued)

ELECTRICAL CHARACTERISTICS — continued ($T_J = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
DIODE CHARACTERISTICS — continued					
Reverse Recovery Time	t_{rr}	—	114	—	ns
	t_a	—	71	—	
	t_b	—	43	—	
Reverse Recovery Stored Charge	Q_{RR}	—	0.65	—	μC
Reverse Recovery Time	t_{rr}	—	226	—	ns
	t_a	—	165	—	
	t_b	—	61	—	
Reverse Recovery Stored Charge	Q_{RR}	—	1.90	—	μC
INTERNAL PACKAGE INDUCTANCE					
Internal Emitter Inductance (Measured from the emitter lead 0.25" from package to emitter bond pad)	L_E	—	13	—	nH

TYPICAL ELECTRICAL CHARACTERISTICS

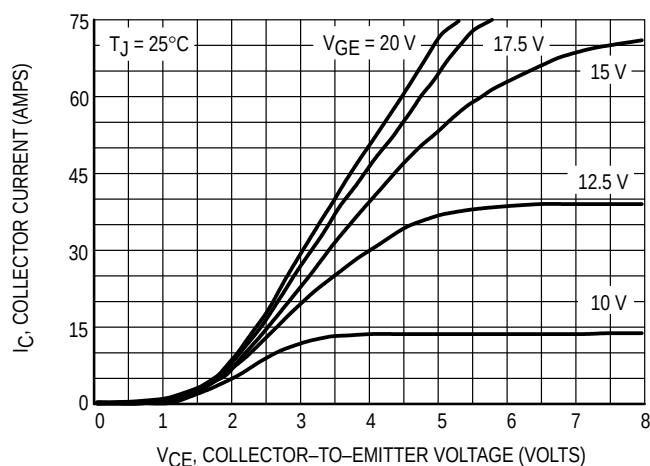


Figure 1. Output Characteristics, $T_J = 25^\circ\text{C}$

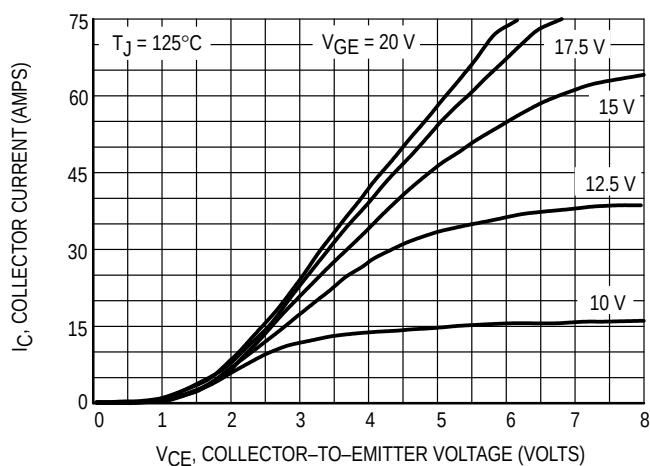


Figure 2. Output Characteristics, $T_J = 125^\circ\text{C}$

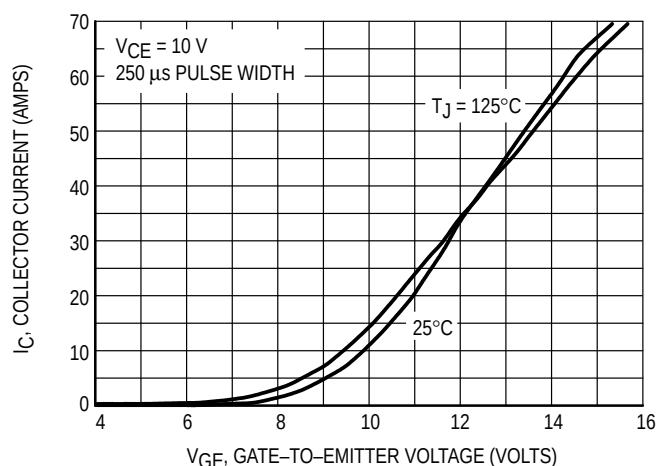


Figure 3. Transfer Characteristics

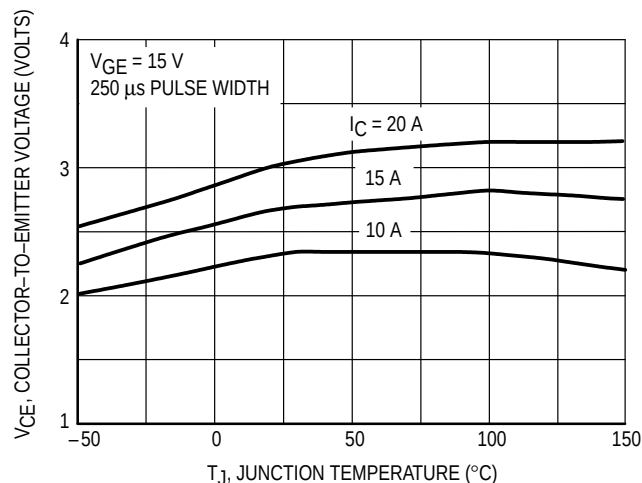


Figure 4. Collector-to-Emitter Saturation Voltage versus Junction Temperature

MGY25N120D

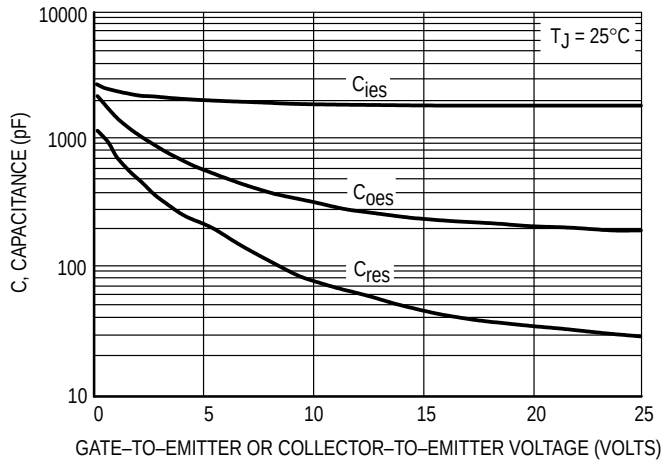


Figure 5. Capacitance Variation

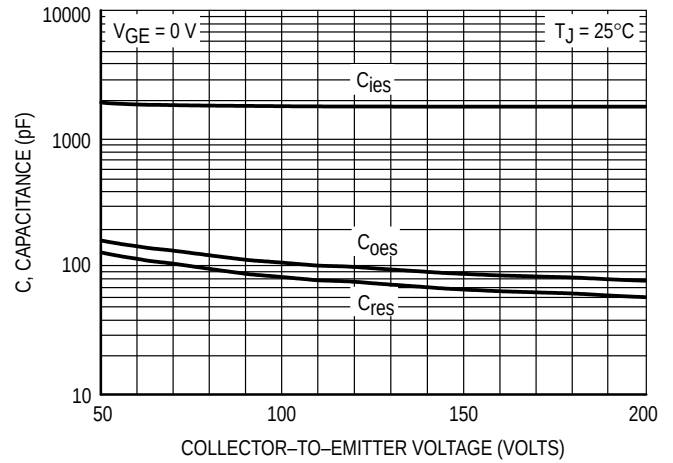


Figure 5b. High Voltage Capacitance Variation

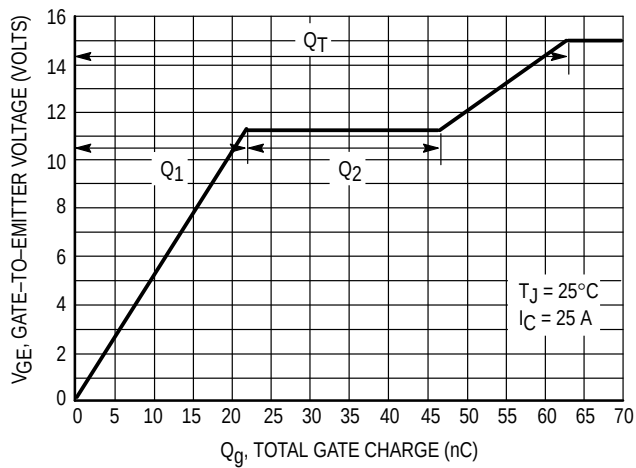


Figure 6. Gate-to-Emitter and Collector-to-Emitter Voltage versus Total Charge

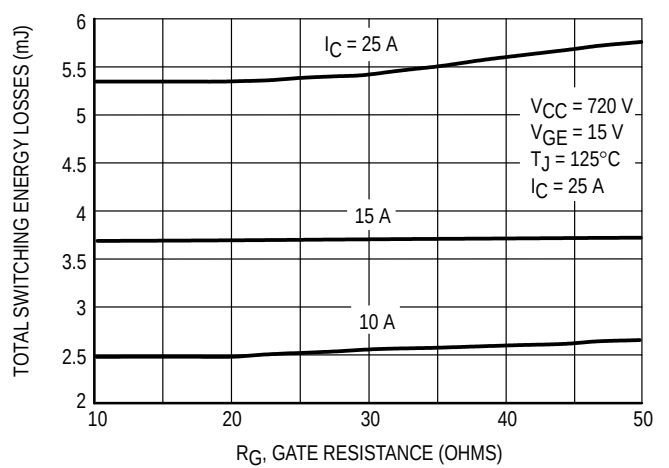


Figure 7. Total Switching Losses versus Gate Resistance

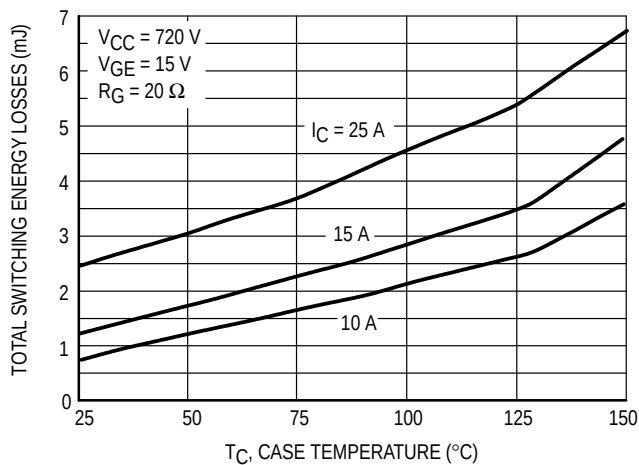


Figure 8. Total Switching Losses versus Case Temperature

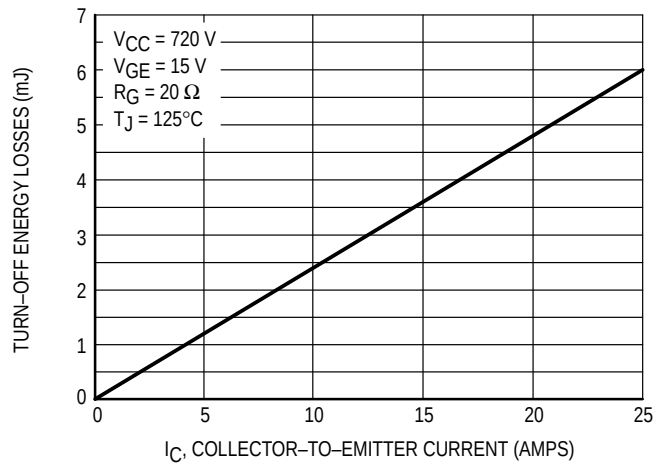


Figure 9. Turn-Off Losses versus Collector-to-Emitter Current

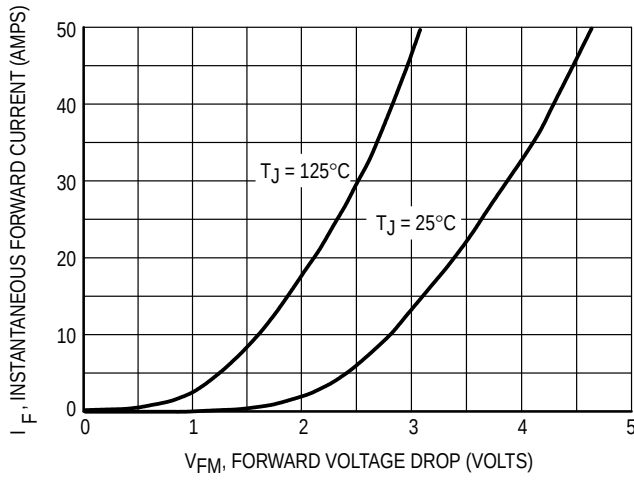


Figure 10. Maximum Forward Drop versus Instantaneous Forward Current

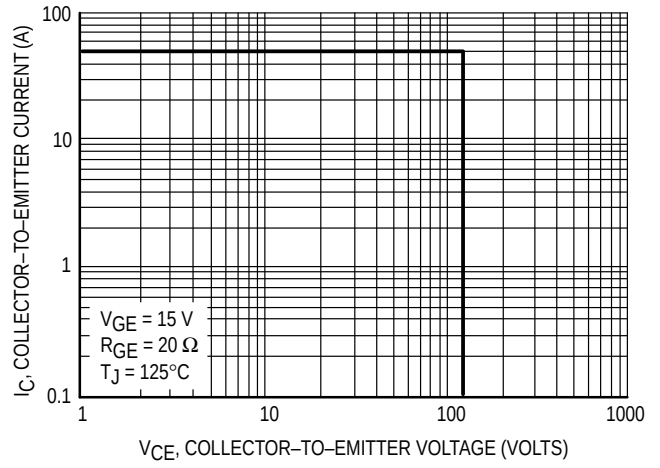


Figure 11. Reverse Biased Safe Operating Area

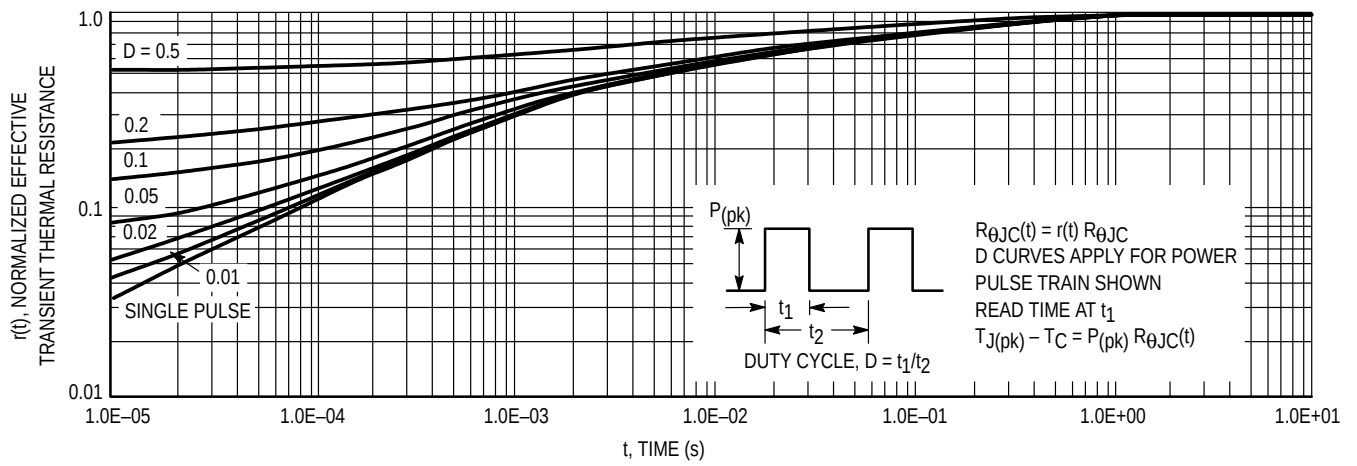
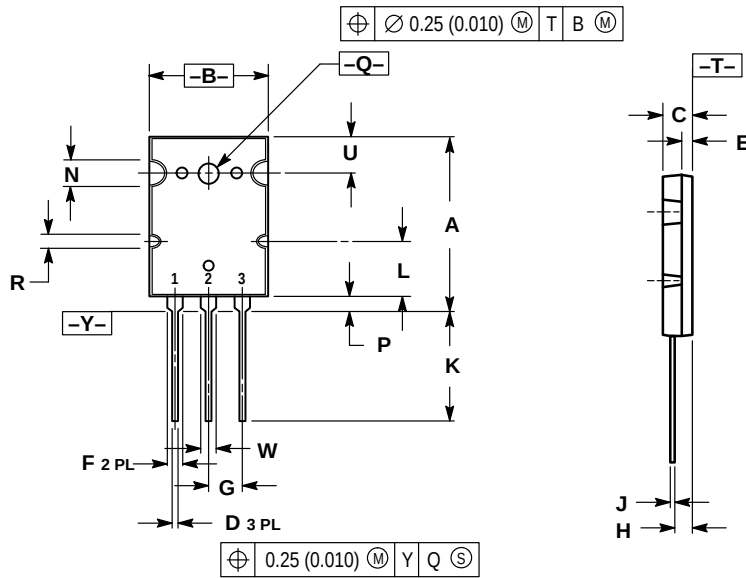


Figure 12. Thermal Response

PACKAGE DIMENSIONS



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	2.8	2.9	1.102	1.142
B	19.3	20.3	0.760	0.800
C	4.7	5.3	0.185	0.209
D	0.93	1.48	0.037	0.058
E	1.9	2.1	0.075	0.083
F	2.2	2.4	0.087	0.102
G	5.45 BSC		0.215 BSC	
H	2.6	3.0	0.102	0.118
J	0.43	0.78	0.017	0.031
K	17.6	18.8	0.693	0.740
L	11.0	11.4	0.433	0.449
N	3.95	4.75	0.156	0.187
P	2.2	2.6	0.087	0.102
Q	3.1	3.5	0.122	0.137
R	2.15	2.35	0.085	0.093
U	6.1	6.5	0.240	0.256
W	2.8	3.2	0.110	0.125

- STYLE 5:
1. GATE
 2. COLLECTOR
 3. EMITTER

CASE 340G-02
TO-264
ISSUE E

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